



# **Rectifier Diode**

**Target Information** 

DS5517-1.0 February 2002

## **FEATURES**

- Double Side Cooling
- High Surge Capability

## **APPLICATIONS**

- Rectification
- Freewheel Diode
- DC Motor Control
- Power Supplies
- Welding
- Battery Chargers

## **VOLTAGE RATINGS**

Type Number	Repetitive Peak Reverse Voltage V	Conditions
DRD420D18	1800	$V_{RSM} = V_{RRM} + 100V$
DRD420D16 DRD420D14	1600 1400	
DRD420D14	1200	

Lower voltage grades available.

# **ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table, e.g.:

#### DRD420D18

Note: Please use the complete part number when ordering and quote this number in any future correspondance relating to your order.

## **KEY PARAMETERS**

 $V_{RRM}$  1800V  $I_{F(AV)}$  4200A  $I_{FSM}$  70000A

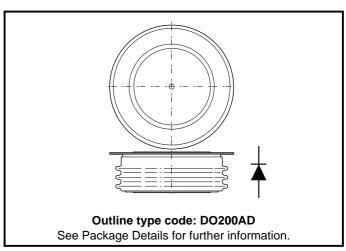


Fig. 1 Package outline



# **CURRENT RATINGS**

# $T_{case} = 75$ °C unless otherwise stated

Symbol	Parameter	Conditions	Max.	Units			
Double Sid	Double Side Cooled						
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load	5150	Α			
I <sub>F(RMS)</sub>	RMS value	-	8090	А			
I <sub>F</sub>	Continuous (direct) forward current	-	7450	А			
Single Side Cooled (Anode side)							
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load	3760	А			
I <sub>F(RMS)</sub>	RMS value	-	5910	А			
I <sub>F</sub>	Continuous (direct) forward current	-	4820	А			

# $T_{case} = 100$ °C unless otherwise stated

Symbol	Parameter	Conditions		Units				
Double Sid	Double Side Cooled							
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load, T <sub>case</sub> = 100°C	4200	А				
I <sub>F(RMS)</sub>	RMS value	T <sub>case</sub> = 100°C	6600	А				
I <sub>F</sub>	Continuous (direct) forward current	$T_{\text{case}} = 100^{\circ}\text{C}$	5980	А				
Single Side	Single Side Cooled (Anode side)							
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load, T <sub>case</sub> = 100°C	3000	А				
I <sub>F(RMS)</sub>	RMS value	T <sub>case</sub> = 100°C	4780	Α				
l <sub>F</sub>	Continuous (direct) forward current	$T_{\text{case}} = 100^{\circ}\text{C}$	3800	Α				



# **SURGE RATINGS**

Symbol	Parameter	Conditions	Max.	Units
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10ms half sine; T <sub>case</sub> = 175°C	56	kA
l²t	I <sup>2</sup> t for fusing	$V_{R} = 50\% V_{RRM} - 1/4 \text{ sine}$	15.68 x 10 <sup>6</sup>	A²s
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10ms half sine; T <sub>case</sub> = 175°C	70	kA
l²t	I <sup>2</sup> t for fusing	V <sub>R</sub> = 0	24.5 x 10 <sup>6</sup>	A²s

# THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions	Conditions		Max.	Units
$R_{th(j-c)}$	Thermal resistance - junction to case	Double side cooled	dc	-	0.013	°C/W
		Cincle side and d	Anode dc	-	0.025	°C/W
		Single side cooled	Cathode dc	-	0.027	°C/W
$R_{\text{th(c-h)}}$	Thermal resistance - case to heatsink	Clamping force 45.0kN	Double side	-	0.003	°C/W
		with mounting compound	Single side	-	0.006	°C/W
$T_{v_{j}}$	Virtual junction temperature	Forward (conducting)		-	185	°C
		Reverse (blocking)		-	175	°C
T <sub>stg</sub>	Storage temperature range			-55	200	°C
-	Clamping force			40.0	48.0	kN



# **CHARACTERISTICS**

Symbol	Parameter	Conditions	Тур.	Max.	Units
I <sub>RRM</sub>	Peak reverse current	At V <sub>RRM</sub> , T <sub>case</sub> = 175°C	-	100	mA
Q <sub>s</sub>	Total stored charge	$I_{F} = 1000A$ , $dI_{RR}/dt = 5A/\mu s$ $-T_{case} = 175^{\circ}C$ , $V_{R} = 100V$	2500	-	μС
I <sub>RR</sub>	Peak recovery current		155	-	А
t <sub>rr</sub>	Reverse recovery time		50	-	μs
V <sub>TO</sub>	Threshold voltage	At T <sub>vj</sub> = 175°C	-	0.75	V
r <sub>T</sub>	Slope resistance	At T <sub>vj</sub> = 175°C	-	0.0494	mΩ

# **CURVES**

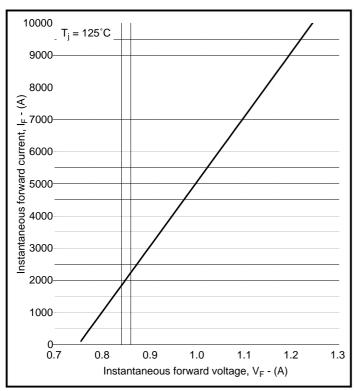


Fig.2 Maximum (limit) forward characteristics

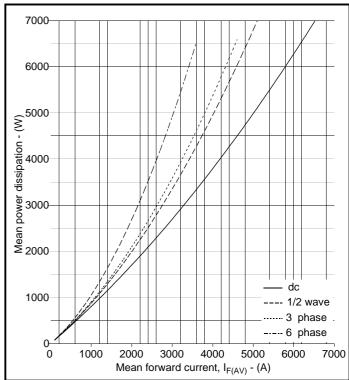
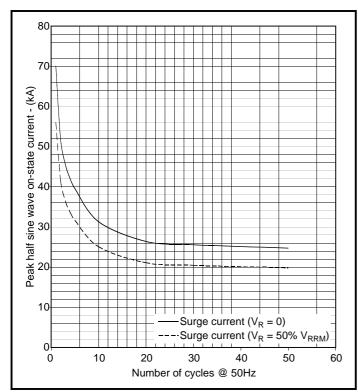


Fig.3 Dissipation curves





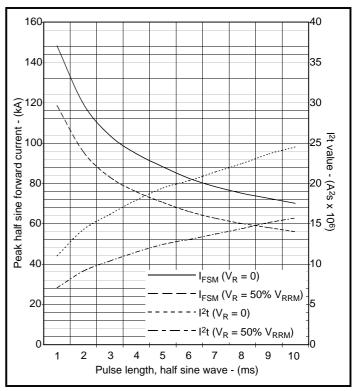


Fig.4 Series multi-cycle surge current

Fig.5 Sub-cycle surge curves

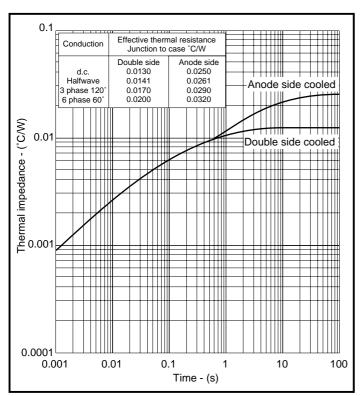
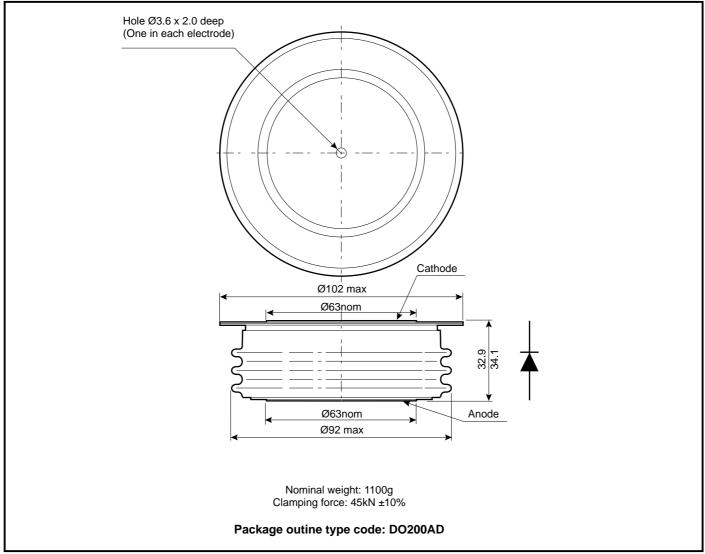


Fig.5 Maximum (limit) transient thermal impedance - junction to case



## **PACKAGE DETAILS**

For further package information, please contact your nearest Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



#### Note:

1. Package maybe supplied with pins and/or tags.



#### **POWER ASSEMBLY CAPABILITY**

The Power Assembly group was set up to provide a support service for those customers requiring more than the basic semiconductor, and has developed a flexible range of heatsink / clamping systems in line with advances in device types and the voltage and current capability of our semiconductors.

We offer an extensive range of air and liquid cooled assemblies covering the full range of circuit designs in general use today. The Assembly group continues to offer high quality engineering support dedicated to designing new units to satisfy the growing needs of our customers.

Using the up to date CAD methods our team of design and applications engineers aim to provide the Power Assembly Complete solution (PACs).

### **DEVICE CLAMPS**

Disc devices require the correct clamping force to ensure their safe operation. The PACs range offers a varied selection of pre-loaded clamps to suit all of our manufactured devices. This include cube clamps for single side cooling of 'T' 22mm

Clamps are available for single or double side cooling, with high insulation versions for high voltage assemblies.

Please refer to our application note on device clamping, AN4839

#### **HEATSINKS**

Power Assembly has its own proprietary range of extruded aluminium heatsinks. They have been designed to optimise the performance or our semiconductors. Data with respect to air natural, forced air and liquid cooling (with flow rates) is available on request.

For further information on device clamps, heatsinks and assemblies, please contact your nearest Sales Representative or Customer Services.



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Target Information: This is the most tentative form of information and represents a very preliminary specification. No actual design work on the product has been started.

Preliminary Information: The product is in design and development. The datasheet represents the product as it is understood but details may change.

Advance Information: The product design is complete and final characterisation for volume production is well in hand.

No Annotation: The product parameters are fixed and the product is available to datasheet specification.

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